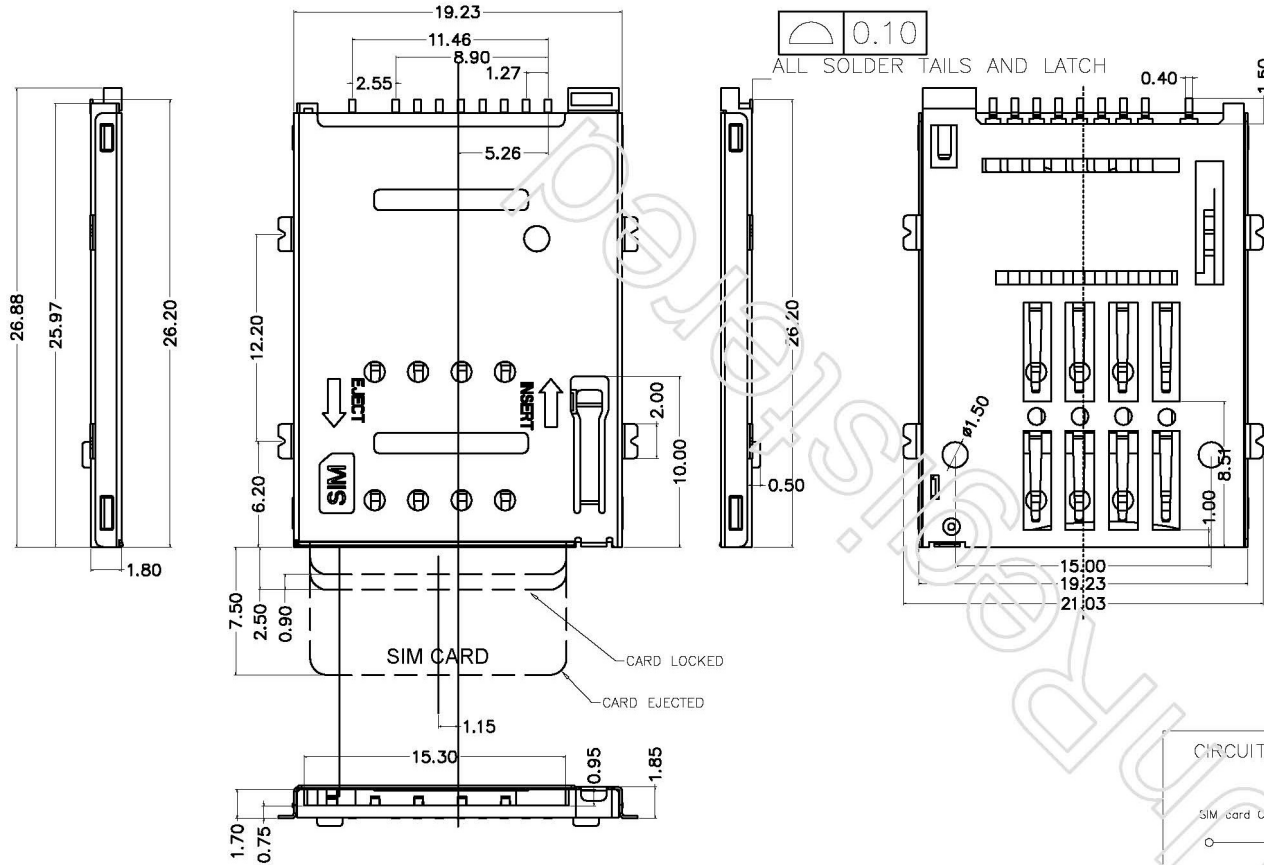
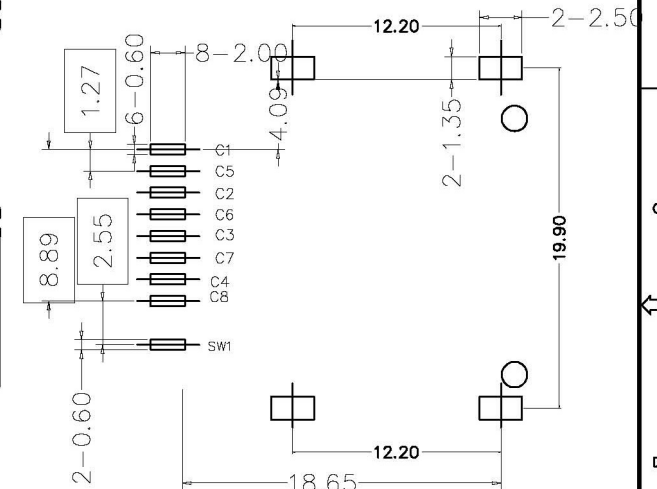


* 所有原料材质, 生产制程, 电镀必须符合ROHS要求



RECOMMENDED PCB LAYOUT



CIRCUIT:



WITHOUT SIM CARD



SIM CARD INSERTED

1. SPECIFICATIONS

INSULATION RESISTANCE: 500M min. AT DC 500V DC
 WITHSTANDING VOLTAGE: 250V AC rms FOR 1 MINUTE
 CONTACT RESISTANCE: 100M max. AT 10MA/20mV max
 CURRENT RATING: 0.5A
 VOLTAGE RATING: 5.0 Vrms
 OPERATING TEMP. RANGE: -55 C+85 C
 MATING CYCLES: 5000 INSERTIONS

2. MATERIAL:

INSULATOR: H-TEMPERATURE PLASTIC, UL 94V-0,
 COLOR: BLACK
 TERMINAL: COPPER ALLOY, T=0.15mm
 SHELL: STAINLESS STEEL, T=0.15mm

3. FINISH:

TERMINAL: 50μm min NICKEL UNDERPLATED ON ALLOVER, GOLD PLATING
 ON CONTACT AREA, 80μm min TIN ON SOLDER TAIL.
 SHELL: 50μm NICKEL UNDERPLATED ON ALLOVER, GOLD FLASH ON SOLDER
 LATCH

SIM pin assignment

PIN#	Name
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved



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DIMENSIONS INIT: mm
 UNLESS OTHERWISE SPECIFIABLE
 DIMENSION TOLERANCE
 X.X: ± 0.25
 X.XX: ± 0.10
 X.XXX: ± 0.05
 ANGULAR: ± 1°

PRODUCT NAME : SIM PUSH 8P+1P有定位	DRAWING: COCO	DATE: 2012/05/10
PRODUCT NO. : XDSM-0863-0112	CHECK: JANY	DATE: 2012/05/10
DRAWING NO. : 0112BAAS06A	APPROVED: JEFF	DATE: 2012/05/10
SCALE: 1:1	DWG ID: P D	REV.: A
		PAGE: 1 of 1

REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
1				
2				